

RCA
Solid State
Division

Power Transistors

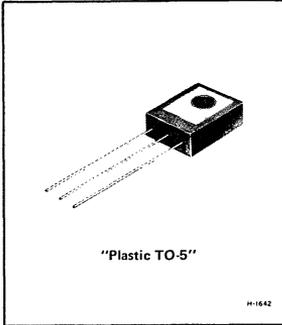
2N6178 2N6180
2N6179 2N6181

Silicon N-P-N & P-N-P Power Transistors

"Plastic TO-5" General-Purpose Types for
Large-Signal, Medium-Power Applications

Features:

- Maximum area-of-operation curves
- Planar construction for low-noise and low-leakage characteristics
- Low saturation voltage (2N6178, 2N6180)
- High beta (2N6179, 2N6181)
- Fast switching (2N6178, 2N6179)
- "Plastic TO-5" package with insulated mounting hole



RCA types 2N6178, 2N6179, 2N6180, and 2N6181* are silicon power transistors intended for large-signal, medium-power applications in industrial and commercial equipment.

The 2N6178 and 2N6179 are triple-diffused silicon n-p-n planar types. These types have features similar to the popular 2N2102 plus higher collector-current ratings and dissipation capability.

Types 2N6180 and 2N6181 (p-n-p complements of the 2N6178 and 2N6179, respectively) are double-diffused, epitaxial-planar devices. These types have features similar to the 2N4036 plus higher collector-current ratings and dissipation capability.

TERMINAL CONNECTIONS

Lead 1 — Emitter

Lead 2 — Base

Lead 3 — Collector

Rectangular Metal Slug-Collector

In addition, these types utilize the new RCA-developed "Plastic TO-5" package. This plastic package has an insulated mounting hole for ease of mounting and heat sinking for optimum thermal contact.

* Formerly RCA Dev. Nos. TA7554-TA7557, respectively.

MAXIMUM RATINGS, Absolute-Maximum Values:

	2N6179	2N6181	2N6178	2N6180	
*COLLECTOR-TO-BASE VOLTAGE	75	-75	100	-100	V
*COLLECTOR-TO-EMITTER VOLTAGE:					
With 1.5 volts (V_{BE}) of reverse bias	75	-75	100	-100	V
With external base-to-emitter resistance					
(R_{BE}) = 100 Ω , sustaining	65	-65	90	-90	V
With base open, sustaining	50	-50	75	-75	V
*EMITTER-TO-BASE VOLTAGE	5	-5	7	-7	V
*CONTINUOUS COLLECTOR CURRENT	2	-2	2	-2	A
*CONTINUOUS BASE CURRENT	1	-1	1	-1	A
*TRANSISTOR DISSIPATION:					
At case temperatures up to 25°C	25	25	25	25	W
At case temperatures above 25°C		See Figs. 1, 2, & 3			
At case temperatures up to 100°C	10	10	10	10	W
At case temperatures above 100°C		See Figs. 3, 4, & 5			
*TEMPERATURE RANGE:					
Storage and operating (Junction)	←----- -65 to 150 -----→				°C
*LEAD TEMPERATURE (During soldering):					
At distance $\geq 1/32$ in (0.8 mm) from					
seating plane for 10 s max	←----- 230 -----→				°C

*In accordance with JEDEC registration data format JS-6/RDF-1.

ELECTRICAL CHARACTERISTICS, at case temperature (T_C) = 25°C, unless otherwise specified.

CHARACTERISTIC	SYMBOL	TEST CONDITIONS					LIMITS								UNITS		
		DC Voltage (V)			DC Current (mA)		Type 2N6178		Type 2N6179		Type 2N6180		Type 2N6181				
		V _{CB}	V _{CE}	V _{BE}	I _C	I _B	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.			
Collector-Cutoff Current With emitter open	I _{CBO}	80 60 -80 -60					-	0.5	-	-	-	-	-	-	-	-	μA
With base open	I _{CEO}		60 45 -60 -45				0 0 0 0	-	1	-	-	-	-	-	-	-	mA
With base reverse-biased	I _{CEV}		100 75 -100 -75	-1.5 -1.5 1.5 1.5			-	0.1	-	-	0.1	-	-	-	-	-	mA
With base reverse-biased and T _C = 100°C			70 45 -70 -45	-1.5 -1.5 1.5 1.5			-	0.5	-	-	0.5	-	-	-0.5	-	-	-0.5
Emitter-Cutoff Current	I _{EBO}		-7 -5 7 5		0 0 0 0		-	0.1	-	-	0.1	-	-	-	-0.1	-	mA
Emitter-to-Base Breakdown Voltage (I _E = 0.1 mA)	V _{(BR)EBO}				0 0		7	-	5	-	-	-	-7	-	-	-5	V
Collector-to-Emitter Breakdown Voltage: With base-emitter junction reverse-biased	V _{(BR)ICEV}			-1.5 1.5	0.1 -0.1		100	-	75	-	-	-	-100	-	-	-75	V
With base open	V _{(BR)ICEO}				100 -100	0 0	75	-	50	-	-	-	-75	-	-	-50	V
Collector-to-Emitter Sustaining Voltage: With external base-to- emitter resistance (R _{BE}) = 100 Ω	V _{CER(sus)} ^a				100 -100		90	-	65	-	-	-	-90	-	-	-65	V
With base open	V _{CEO(sus)} ^a				100 -100	0 0	75	-	50	-	-	-	-75	-	-	-50	V
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}				500 -500	50 -50	-	0.5	-	0.8	-	-	-	-0.7	-	-1.2	V
Base-to-Emitter Saturation Voltage	V _{BE(sat)}				500 -500	50 -50	-	1.2	-	1.5	-	-	-	-1.2	-	-1.5	V
Output Capacitance (At 1 MHz)	C _{obo}	10 -10					12	20	12	20	-	-	25	40	25	40	pF
DC Forward-Current Transfer Ratio	h _{FE}		4 -4 2 -2 2 -2		50 -50 500 ^b -500 ^b 1000 ^b -1000 ^b		30	130	40	250	-	-	30	130	40	250	
Second-Breakdown Collector Current c, d (With base forward-biased)	I _{S/b}		V _{CC} = 50 -50				200	-	200	-	-	-	-150	-	-	-150	mA
Gain-Bandwidth Product	f _T		4 -4		50 -50		50	-	50	-	-	50	-	50	-	-	MHz
Magnitude of Common Emitter, Small-Signal, Short- Circuit Forward-Current Transfer Ratio (f = 10 MHz)	h _{fe}		4 -4		50 -50		5	-	5	-	-	5	-	5	-	-	

Chart continued on page 3.

CHARACTERISTIC	SYMBOL	TEST CONDITIONS						LIMITS								UNITS
		DC Voltage (V)			DC Current (mA)			Type 2N6178		Type 2N6179		Type 2N6180		Type 2N6181		
		V _{CB}	V _{CE}	V _{BE}	I _C	I _B	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
Saturated Switching Time: (See Fig. 30 & 31) Turn-on Time	t _{on}	V _{CC} ^a 30 -30			500 -500	50 -50	-	80	-	80	-	-	100	-	100	ns
Turn-off Time	t _{off}	V _{CC} ^a 30 -30			500 -500	50 -50	-	800	-	800	-	1000	-	1000	ns	
Thermal Resistance: Junction-to-Case	R _{θJC}						-	5	-	5	-	5	-	5	°C/W	
Junction-to-Ambient	R _{θJA}						-	156	-	156	-	156	-	156	°C/W	

^a In accordance with JEDEC registration data format JS-6/RDF-1.

^c Safe operating regions for forward-bias operation are shown on Figs. 1, 2, 4, and 5.

^b Pulsed; pulse duration ≤ 300 μs, duty factor ≤ 0.02.

^d Pulsed: 0.4s, non-repetitive pulse.

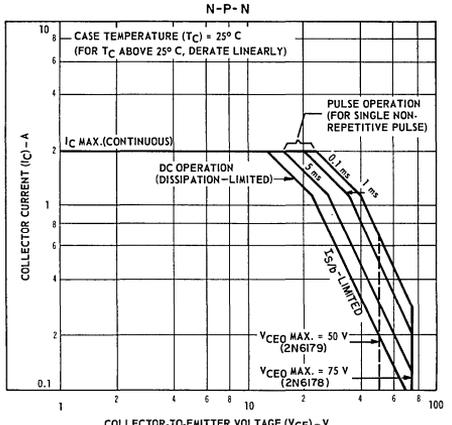


Fig.1—Maximum operating areas for 2N6178 and 2N6179 at T_C=25°C.

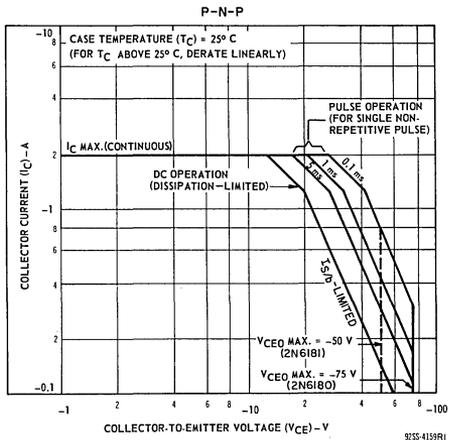


Fig.2—Maximum operating areas for 2N6180 and 2N6181 at T_C=25°C.

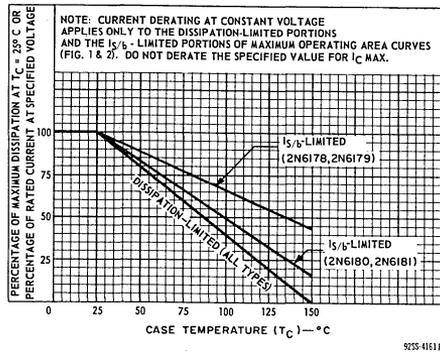


Fig.3—Derating curves for all types.

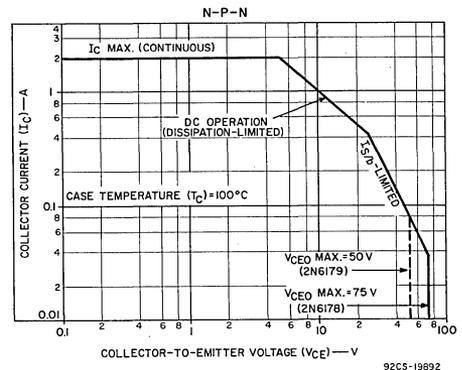


Fig.4—Maximum operating areas for 2N6178 and 2N6179 at T_C=100°C.

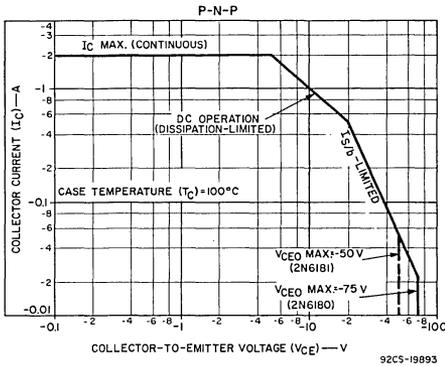


Fig. 5—Maximum operating areas for 2N6180 and 2N6181 at $T_C=100^\circ\text{C}$.

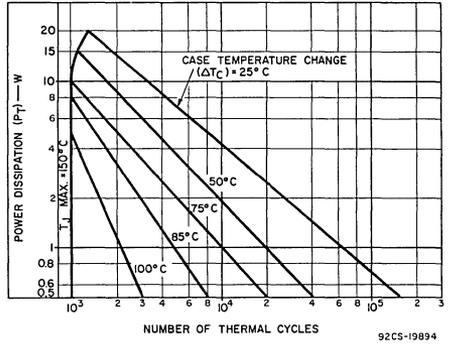


Fig. 6—Thermal-cycling rating chart for all types.

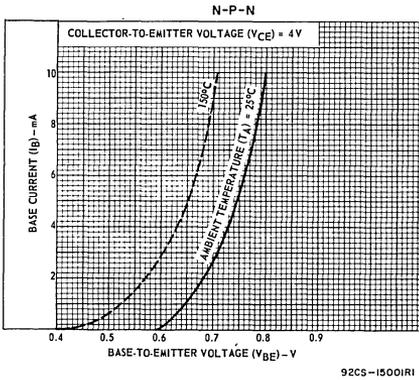


Fig. 7—Typical input characteristics for 2N6178 and 2N6179.

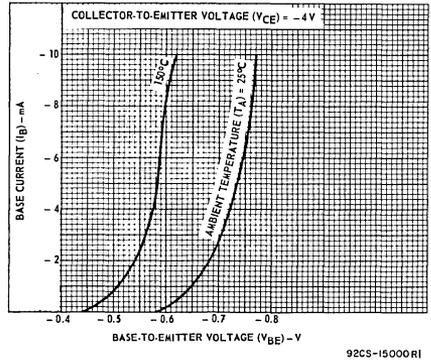


Fig. 8—Typical input characteristics for 2N6180 and 2N6181.

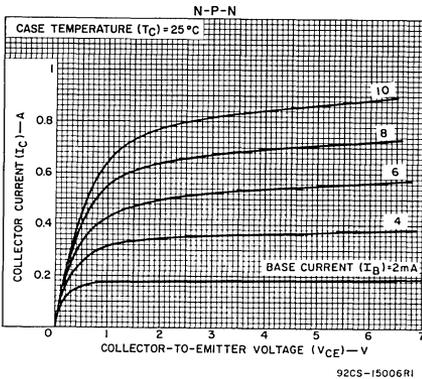


Fig. 9—Typical output characteristics for 2N6178 and 2N6179.

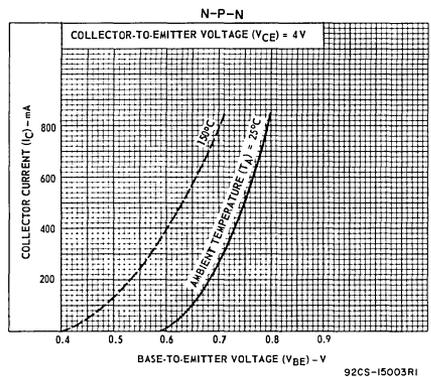


Fig. 10—Typical transfer characteristics for 2N6178 and 2N6179.

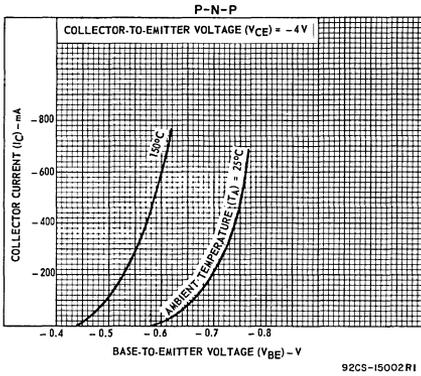


Fig. 11—Typical transfer characteristics for 2N6180 and 2N6181.

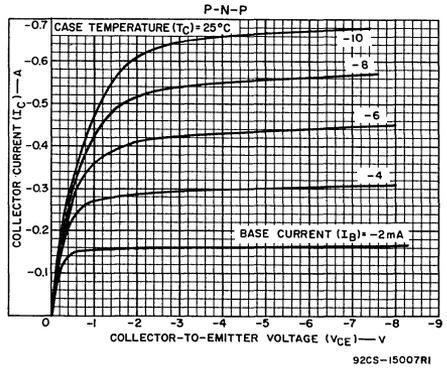


Fig. 12—Typical output characteristics for 2N6180 and 2N6181.

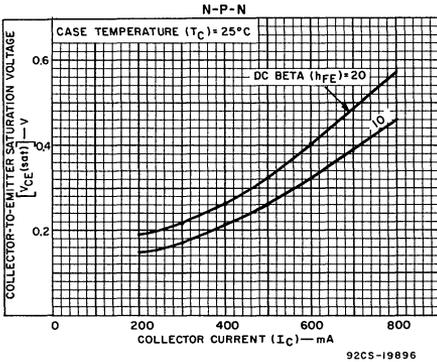


Fig. 13—Typical saturation-voltage characteristics for 2N6178 and 2N6179.

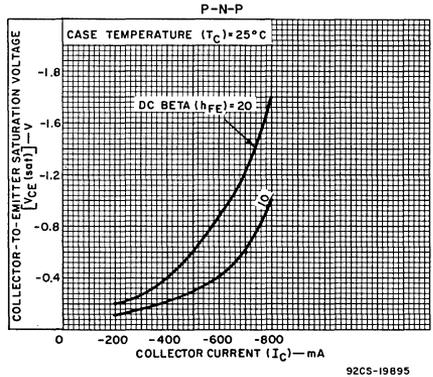


Fig. 14—Typical saturation-voltage characteristics for 2N6180 and 2N6181.

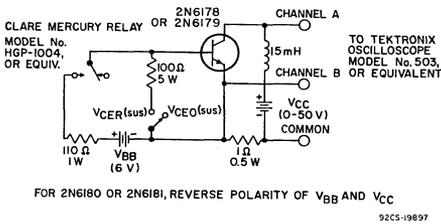


Fig. 15—Circuit used to measure sustaining voltages $V_{CE0(sus)}$ and $V_{CER(sus)}$.

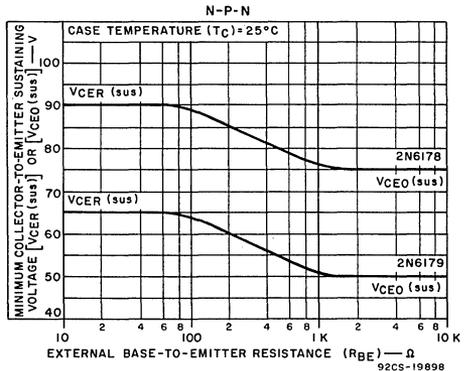


Fig. 16—Collector-to-emitter sustaining voltage characteristics for 2N6178 and 2N6179.

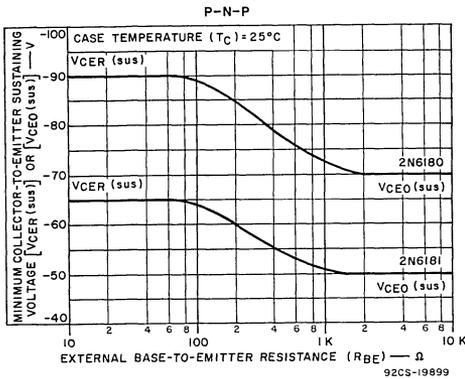
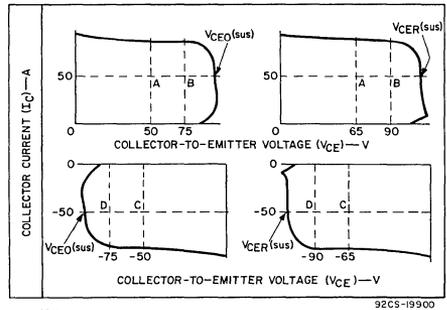


Fig. 17—Collector-to-emitter sustaining voltage characteristics for 2N6180 and 2N6181.



NOTE: SUSTAINING VOLTAGES $V_{CE0(sus)}$ AND $V_{CE(sus)}$ ARE ACCEPTABLE WHEN TRACES FALL TO THE RIGHT AND ABOVE POINTS "A" FOR TYPE 2N6179 POINTS "B" FOR TYPE 2N6178, TO THE LEFT AND BELOW POINTS "C" FOR TYPE 2N6181, AND POINTS "D" FOR TYPE 2N6180.

Fig. 18—Oscilloscope display for measurement of sustaining voltages (test circuit shown in Fig. 15).

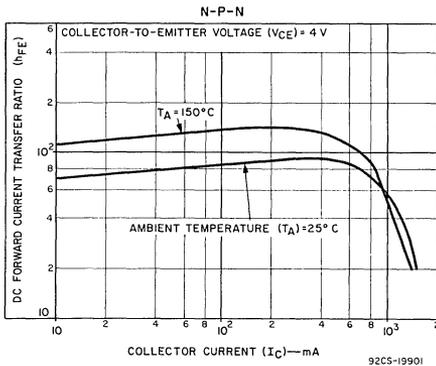


Fig. 19—Typical dc beta characteristics for 2N6178 and 2N6179.

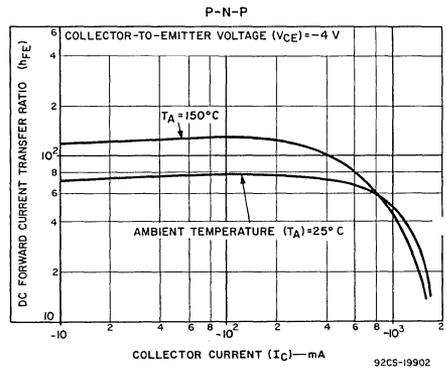


Fig. 20—Typical dc beta characteristics for 2N6180 and 2N6181.

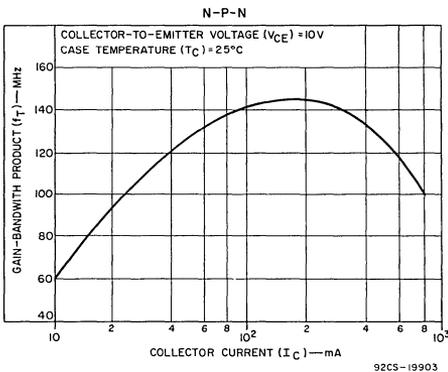


Fig. 21—Typical gain-bandwidth product for 2N6178 and 2N6179.

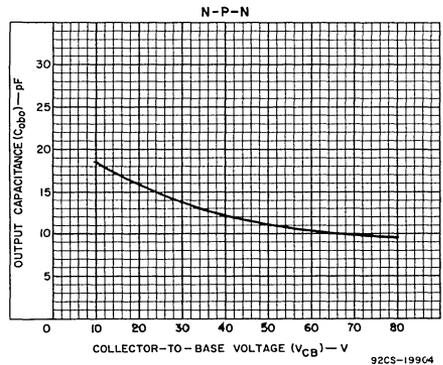


Fig. 22—Typical output capacitance vs. collector-to-base voltage for 2N6178 and 2N6179.

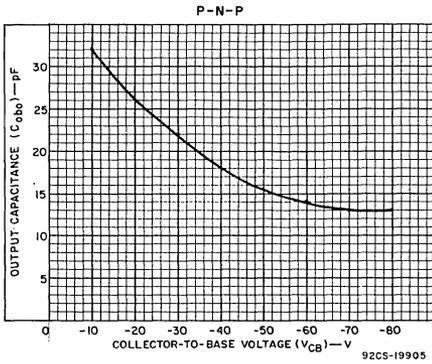


Fig. 23—Typical output capacitance vs. collector-to-base voltage for 2N6180 and 2N6181.

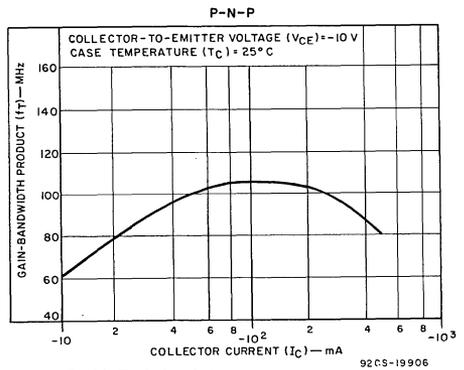


Fig. 24—Typical gain-bandwidth product for 2N6180 and 2N6181.

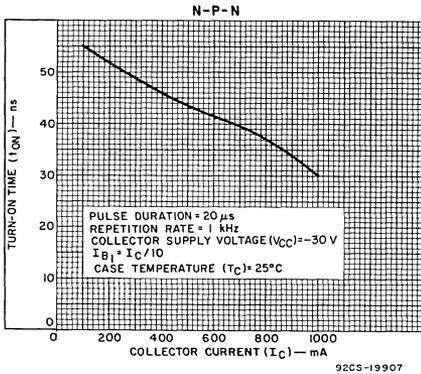


Fig. 25—Typical turn-on time for 2N6178 and 2N6179.

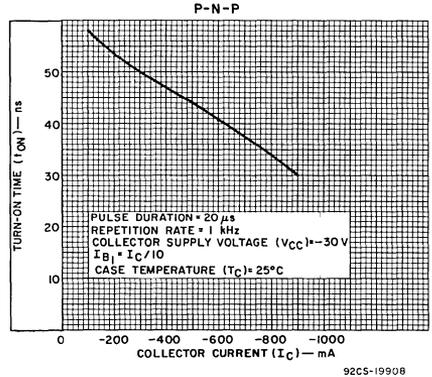


Fig. 26—Typical turn-on time for 2N6180 and 2N6181.

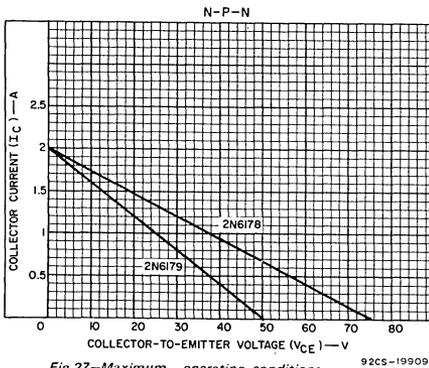


Fig. 27—Maximum operating conditions, resistive-load switching between saturation and cutoff for 2N6178 and 2N6179.

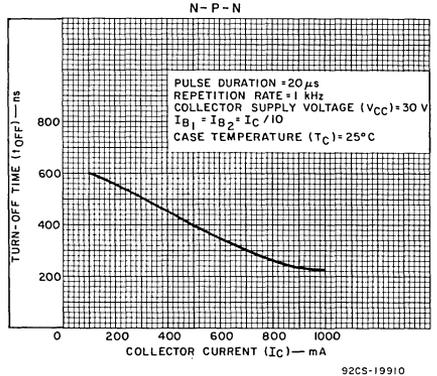


Fig. 28—Typical turn-off time for 2N6178 and 2N6179.

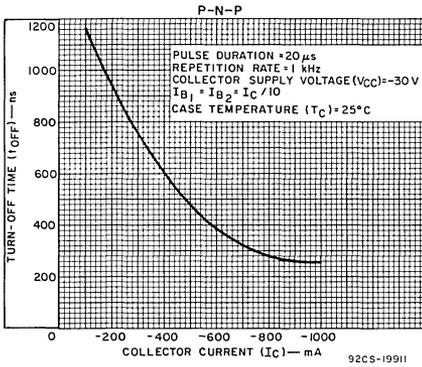


Fig.29—Typical turn-off time for 2N6180 and 2N6181.

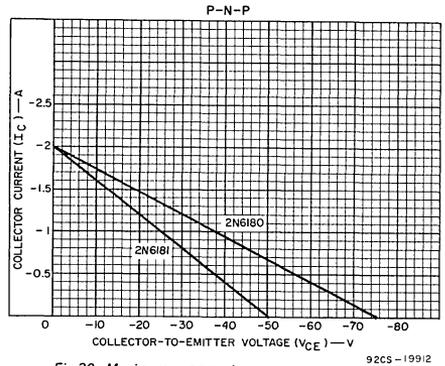


Fig.30—Maximum operating conditions, resistive-load switching between saturation and cutoff for 2N6180 and 2N6181.

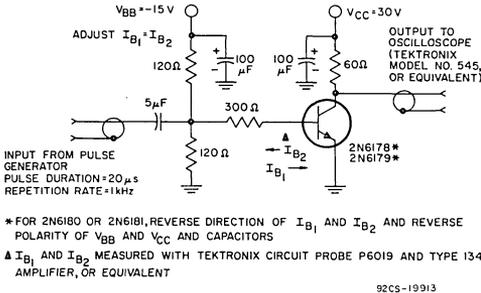


Fig.31—Circuit used to measure switching times for all types.

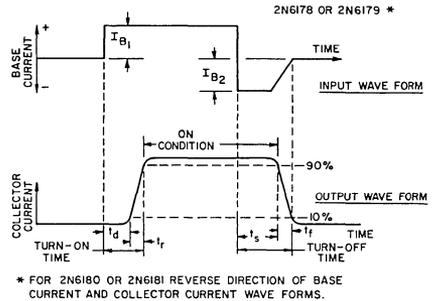


Fig.32—Phase relationship between input current and output voltage showing reference points for specification of switching times (test circuit shown in Fig.31).